



PATENT 2811

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Leo M. Higgins, III
Serial No.: 10/085,224
Filed: February 28, 2002
Title: Method and Structure of In-Situ
Wafer Scale Polymer Stud Grid
Array Contact Formation

Examiner: Unknown
Group Art No.: 2811
Atty. Dkt. No.: 2001P07506US01

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Date

11/21/02

Nancy Demko

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, DC 20231

Sir:

Pursuant to 37 C.F.R. § 1.97 and § 1.98 and to the duties imposed by 37 C.F.R. § 1.56, the Examiner in charge of the above-identified case is requested to consider and make of record the references listed on Form PTO 1449 submitted herewith.

A copy of each of these documents is also enclosed. Applicants respectfully request that an initialed copy of the Form PTO-1449 be returned in accordance with M.P.E.P. § 609. Under 37 C.F.R. §1.97 (g), the filing of this information disclosure statement shall not be construed as an admission against interest in any manner or as an admission that the information reported is, or is considered to be, prior art or material to patentability. The filing of this information disclosure statement shall not be construed as a representation that a search has been made.

Each item of information contained in this Information Disclosure Statement was cited in an International Search Report in the counterpart International Application No. PCT/US02/06527. A copy of the PCT International Search Report is attached.

It is not believed that any fee is due in connection with the communication; however, should any fee be due, the Assistant Commissioner is authorized to charge **Deposit Account No. 19-2179**, therefore.

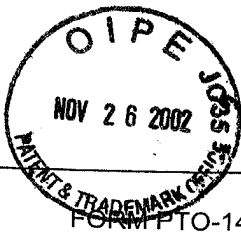
Dated: 11/21/02

Respectfully Submitted,



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FORM PTO-1449
INFORMATION DISCLOSURE STATEMENT

ATTY. DKT.
NO.:2001P07506US01

SERIAL NO.: 10/085,224

APPLICANT(s): Leo M. Higgins, III

FILING DATE: 02/28/2002

GROUP ART UNPT: 2811

U.S. PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE
	5,508,228	4/16/1996	Nolan et al.	437	183	2/14/1994
	5,877,556	3/2/1999	Jeng et al.	257	737	3/10/1997
	5,962,918	10/5/1999	Kimura	257	738	10/13/1998
	6,277,669B1	8/21/2001	Kung et al.	438	106	9/15/1999

FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB- CLASS	TRANSLATION

OTHER (Including Author, Title, Date, Pertinent Pages, etc.)

		PCT International Search Report – PCT/US 02/06527
		Siemens Dematic Electronics Assembly Systems, Inc.

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.